

## TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

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| <b>Title of<br/>Invention</b>  | <b>SPECIFIC SITE BACKSIDE UNDERLAYING AND MICROMASKING<br/>METHOD FOR ELECTRICAL CHARACTERIZATION OF SEMICONDUCTOR<br/>DEVICES</b> |                            |
| Application Number :   |  |                            |
| Date :   |  |                            |
| First Named Applicant:   | Barbara A. Averill   |                            |
| Confirmation Number:   |  |                            |
| Attorney Docket Number:  | FIS920030275US1  |                            |
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| Submitted By:  |  | Elec. Sign.                |
| Sean F. Sullivan<br>Registered Number: 38,328  |  | Sign. Capacity<br>Attorney |

| Documents being submitted: | Files  |
|----------------------------|--|
| us-fee-sheet               | ePAVE-usfees.xml<br>us-fee-sheet.xsl<br>us-fee-sheet.dtd   |
| us-ids                     | ePAVE-usidst.xml<br>us-ids.dtd<br>us-ids.xsl   |
| us-assignment              | ePAVE-usassn.xml<br>us-assignment.xsl<br>us-assignment.dtd<br>Assignmentp1.tif<br>Assignmentp2.tif<br>Assignmentp3.tif<br>Assignmentp4.tif   |
| us-request                 | ePAVE-usrequ.xml<br>us-request.dtd<br>us-request.xsl   |
| us-declaration             | Declarationp1.tif  |
| us-declaration             | Declarationp2.tif  |
| us-declaration             | Declarationp3.tif  |
| us-declaration             | Declarationp4.tif  |
| us-declaration             | Declarationp5.tif  |
| us-declaration             | Declarationp6.tif  |
| us-declaration             | Declarationp7.tif  |
| us-declaration             | Declarationp8.tif  |
| application-body           | Specification-trans.xml<br>us-application-body.xsl<br>application-body.dtd<br>wipo.ent<br>mathml2.dtd<br>mathml2-qname-1.mod<br>isoamsa.ent<br>isoamsb.ent<br>isoamsc.ent<br>isoamsn.ent<br>isoamso.ent<br>isoamsr.ent<br>isogr3.ent<br>isomfrk.ent<br>isomopf.ent<br>isomscr.ent<br>isotech.ent<br>isobox.ent<br>isocyr1.ent<br>isocyr2.ent<br>isodia.ent<br>isolat1.ent<br>isolat2.ent<br>isonum.ent<br>isopub.ent |

mmlextra.ent  
mmlalias.ent  
soextblx.dtd  
Figure1.tif  
Figures234.tif  
Figures65.tif

Comments